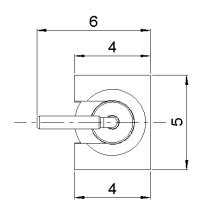
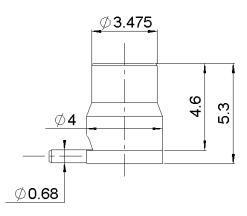


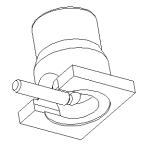


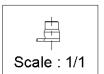
FEMALE STRAIGHT RECEPTACLE FOR PCB CMS TYPE - BOBINE DE 500

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All dimensions are in mm.



COMPONENTS	MATERIALS	PLATING (μm)
Body	BRASS	NPGR
Center contact	BERYLLIUM COPPER	GOLD OVER NICKEL
Outer contact	-	-
Insulator	PTFE	
Gasket	-	
Others parts	-	-
-	-	-
-	-	-



Technical Data Sheet

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PACKAGING

Standard	Unit	Other	
500	Contact us	Contact us	

ELECTRICAL CHARACTERISTICS

Impedance ${\bf 50}$ Ω Frequency ${\bf 0-6}$ ${\bf GHz}$

x F(GHz) Maxi √F(GHz) dB Maxi VSWR 0.0000 Insertion loss NA - F(GHz)) dB Maxi RF leakage - (Voltage rating 250 Veff Maxi Dielectric withstanding voltage 500 Veff mini Insulation resistance 1000 $M\Omega$ mini

MECHANICAL CHARACTERISTICS

Center contact retention

 Axial force – Mating End
 10*
 N mini

 Axial force – Opposite end
 10*
 N mini

 Torque
 NA
 N.cm mini

Recommended torque

 $\begin{array}{ccc} \text{Mating} & & \textbf{NA} & \text{N.cm} \\ \text{Panel nut} & & \textbf{NA} & \text{N.cm} \end{array}$

Mating life 500 Cycles mini Weight 0.3440 g

ENVIRONMENTAL

Operating temperature -55/+155 °C
Hermetic seal NA Atm.cm3/s
Panel leakage NA

SPECIFICATION

OTHER CHARACTERISTICS

Assembly instruction:

Others:

* after soldering (apres soudure)

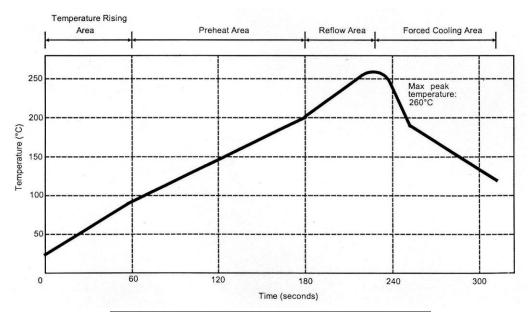


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SOLDER PROCEDURE IN INDUSTRIAL ENVIRONMENT

- 1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 microns (.006 inch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
 - Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

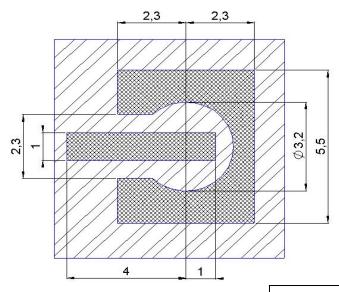




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STANDARD PAD





Masse + vernis Ground + varnish



Plots de soudure Lands for solder paste

COPLANAR LINE

Pattern and signal are on the same side.

Thickness of the PCB: 1.6 mm

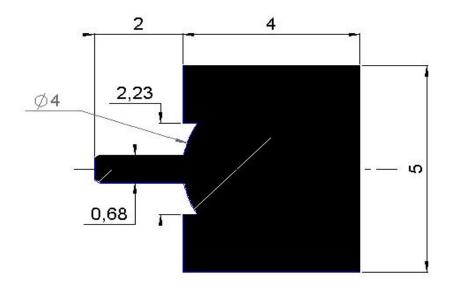
The material of the PCB is the epoxy resin of glass

fabrics bacs (ER: 4.8)

The solder resist should be printed except for

the land pattern on the PCB.

SHADOW OF RECEPTACLE FOR VIDEO CAMERA

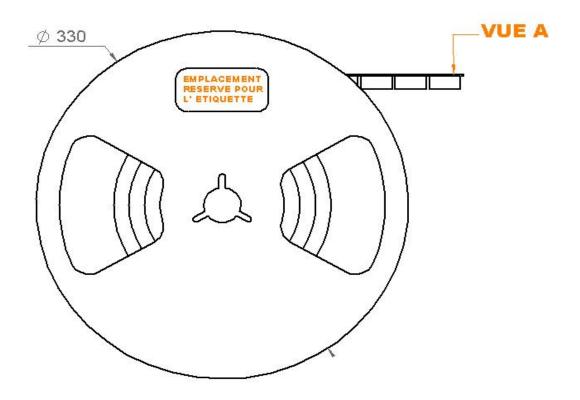


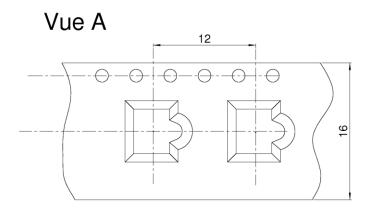


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